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Condition Mainly Used With Binary Logic Elements Where The Logic State 1 (TRUE) Is Converted To A Logic State 0 (FALSE) Or Vice Versa [IEC 60617-12, IEC 61082-2] 3.20 Logic Inversion Condition Mainly Used With Binary Logic Elements Where A Higher Physical Level Is Converted To A Lower Physical Level Or Vice Versa [12th, 2024

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Plasma Etching, Taking Polysilicon Etching With Chlorine As An Example. Radio Frequency (RF) Or Microwave Power (source Power) Generates And Sustains A Plasma In A Partially Evacuated Chamber. In The Example Of figure 1 The Plasma Is Powered By An RF Inductive Coil On Top Of A Dielectric Window. Feed Gas (e.g. Chlorine) Enters The Reactor At 3th, 2024

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